

Form PTO-1449

U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICE

SEP 19 2005

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MI40-382SERIAL NO.
10/705,685APPLICANT
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2632

U.S. PATENT DOCUMENTS

Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
	AA						
	AB						
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FOREIGN PATENT DOCUMENTS

		Document Number	Date	Country	Class	Subclass	Translation	
							Yes	No
TN	AH	DE 41 20 265 A1	6/1991	Germany (Mitsubishi) See US 5,274,221 (prev. cited)	G06K	7/01	Abs	
	AJ	GB 1 567 784	5/1980	United Kingdom	G06K	19/00		
	AK	JP 1-191082	8/1989	Japan (Sony Corp.)	G01S	013/74	Abs	
TN	AL	JP 2-36476	3/1990	Japan (Fujitsu Ltd)	G06F	015/40	Abs	

OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)

TN	AM	CASSON, K., et al., "High Temperature Packaging: Flip Chip on Flexible Laminate", <u>Surface Mount Technology</u> , pp. 19-20 (1/1992)
	AN	JOHNSON, R.W., "Polymer Thick Films: Technology and Materials", <u>Circuits Manufacturing</u> (reprint), 4 pages (7/1982)
	AO	GILLEO, K., "Using SM Devices on Flexible Circuitry", <u>ELECTRONICS</u> , pp. 20-23 (3/1986)
TN	AP	KANATZIBIS, Mercouri G., "Conductive Polymers", <u>Chemical and Engineering News--American Chemical Society</u> , pp. 36-54 (12/1990)
EXAMINER		DATE CONSIDERED

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

Languyen

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Sheet 2 of 2

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TN	AH	JP 2-179794	7/1990	Japan (Sony Corp.)	B42D	015/10	Abs	
TN	AJ	JP 3-224799	10/1991	Japan (Sony Corp.)	B42D	015/10	Abs	
TN	AK	JP 4-359183	11/1992	Japan (Nippondenso Co. Ltd)	G01S	013/80	Abs	
	AL							

OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)

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	AN	
	AO	
	AP	

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